Maxwell Stonham

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Education

Master of Science in Electrical Engineering

University of Nevada, Las Vegas

GPA: 4.00

Bachelor of Science in Electrical Engineering (Minor in Mathematics)

University of Nevada, Las Vegas

GPA: 3.87 (Cum Laude)

• Honors & Awards: Dean's Honor List (Fall 2020 - Fall 2022), NV Space Grant, Marjorie & Victor Kunkel Scholarship

• Activities: IEEE, Tau Beta Pi (Engineering Honor Society), Avionics Member for RebelSat (UNLV's CubeSat mission)

Experience

Graduate Teaching AssistantUniversity of Nevada, Las Vegas

August 2023 – Present

August 2023 - May 2025

August 2020 - May 2023

Las Vegas, Nevada

Las Vegas, Nevada

Las Vegas, Nevada

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Tutoring, grading, and coordinating a Digital Logic Design class and lab (utilizing the Cyclone IV FPGA devices)

Lab Supervisor (Electrical & Computer Engineering Department)

January 2022 - May 2023

University of Nevada, Las Vegas

Assembled over 200 kits per semester for classes containing microcontrollers, FPGAs, and other electronics

- Managed purchase orders of electronics needed for the labs to make sure that our inventory is up to date
- Proficiently handled and maintained lab equipment (oscilloscopes, multimeters, function generators, power supplies)
- Trained and managed a team to ensure a smooth transition for new hires in handling equipment and completing tasks

Aerospace Electronics Reliability Intern

September 2022 – December 2022

NASA (National Aeronautics and Space Administration)

Remote (Greenbelt, Maryland)

- Analyzed testing methods for commercial-off-the-shelf (COTS) parts used in constrained CubeSat missions
- Conducted studies on success and failure rates in university-led CubeSat missions and propose solutions
- Performed risk & reliability assessments and studied radiation concerns/effects on COTS parts in low Earth orbit

Projects

Buck Converter Design Fall 2023

- Designed the circuit schematic and layout of a buck converter using ON Semiconductor's C5 (0.5um) CMOS process through Cadence Virtuoso to convert 4 - 5.5V to 3.125V at 100mA
- Tested the efficiency, power dissipation, and output at different loads using the hysteresis control chosen
- Implemented and laid out a bandgap, comparator, ring oscillator, latch circuit, and various other logic gates

Low-Voltage Differential Signaling Model

Fall 2023

- Designed a Cyclone V to Cyclone V SoC high speed signaling model to transmit a bipolar differential signal (400mV voltage swing) along a 40cm PCB trace at 1Gbps taking into consideration timing, noise, and board stack-up
- Simulated an eye diagram using LTspice and included PCB parasitics (bond wire, ball, vias) for accurate results

Wearable Sensor-Based Knee Rehabilitation Device (Senior Design Project)

Fall 2022 – Spring 2023

- First Prize Winner for UNLV's Spring 2023 Senior Design Competition
- Designed a device to use alongside physical therapists for remote rehabilitation for patients with knee osteoarthritis
- Developed a PCB and 3D model that was fabricated and printed for the device to be operational
- Integrated the device to a smartphone-app for patients to choose exercise routines that monitors and tracks progress

Flyback Switch-Mode Power Supply Design

Fall 2022

- Designed a flyback converter using LTspice to convert 100-130V (AC) at 60Hz to 5V (DC) at 1A for a USB charger
- Simulated and tested the circuit's power dissipation and efficiency using LTspice and offered solutions to problems
- Applied a PWM control circuit using COTS parts to regulate the output voltage at 5V given different loads

Skills

Languages: C, C++, Python, SystemVerilog, RISC-V Assembly Language

Software: LTspice, Cadence Virtuoso, KiCad, MATLAB, Microchip Studio, Arduino, Multisim, Quartus II, Modelsim Coursework: Circuits II, Electromagnetics I, Signals and Systems II, Digital IC Design, Optics, Sensors,

Computer Science I (C++), Digital Logic Design II, Control Systems, Embedded System Design, Power Electronics, Digital Signal Processing, Intro to Biomedical Devices, High Speed PCB Design,

Memory Circuit Design, Embedded Machine Learning